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(54) **RESIN COMPOSITION FOR INJECTION
MOLDING**

(57) Abstract:

PURPOSE: To provide a resin composition for injection molding capable of giving a molded article having excellent rigidity and impact resistance.

CONSTITUTION: The resin composition for injection molding is composed of 30-94wt.% of a highly crystalline polypropylene resin having high isotactic pentad fraction, 5-50wt.% of talc having an average particle diameter of

1-15 μ m and 1-20wt.% of a rubber such as an ethylene-propylene rubber. A molded article having excellent rigidity and impact resistance can be produced from the composition.

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